

| | |
|---------------------|-------------|
| V_{DSS} | -30V |
| $R_{DS(on)}$ (Max.) | 7m Ω |
| I_D | -14A |
| P_D | 2.0W |

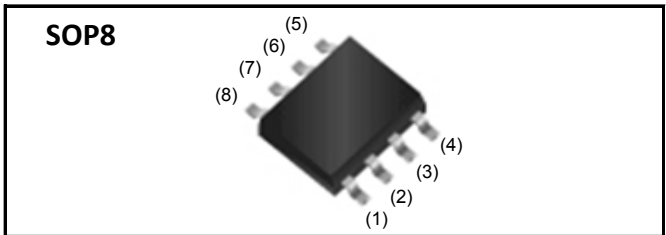
●Features

- 1) Low on - resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small Surface Mount Package (SOP8).
- 4) Pb-free lead plating ; RoHS compliant

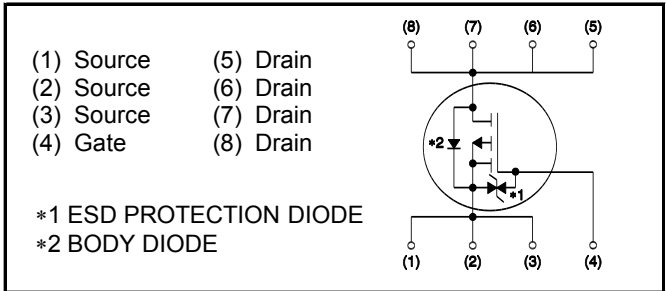
●Application

DC/DC Converter

●Outline



●Inner circuit



●Packaging specifications

| Type | Packaging | Taping |
|------|---------------------------|-----------|
| | Reel size (mm) | 330 |
| | Tape width (mm) | 12 |
| | Basic ordering unit (pcs) | 2,500 |
| | Taping code | TB |
| | Marking | RRH140P03 |

●Absolute maximum ratings($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Value | Unit |
|--------------------------------|--------------------|-------------|------------------|
| Drain - Source voltage | V_{DSS} | -30 | V |
| Continuous drain current | I_D^{*1} | ± 14 | A |
| Pulsed drain current | $I_{D,pulse}^{*2}$ | ± 56 | A |
| Gate - Source voltage | V_{GSS} | ± 20 | V |
| Avalanche energy, single pulse | E_{AS}^{*3} | 1.6 | mJ |
| Power dissipation | P_D^{*4} | 2.0 | W |
| | P_D^{*5} | 0.65 | W |
| Junction temperature | T_j | 150 | $^\circ\text{C}$ |
| Range of storage temperature | T_{stg} | -55 to +150 | $^\circ\text{C}$ |

●Thermal resistance

| Parameter | Symbol | Values | | | Unit |
|--|-----------------|--------|------|------|------|
| | | Min. | Typ. | Max. | |
| Thermal resistance, junction - ambient | R_{thJA}^{*4} | - | - | 62.5 | °C/W |
| Thermal resistance, junction - ambient | R_{thJA}^{*5} | - | - | 192 | °C/W |

●Electrical characteristics($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Conditions | Values | | | Unit |
|--|---|--|--------|------|----------|---------------|
| | | | Min. | Typ. | Max. | |
| Drain - Source breakdown voltage | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = -1mA$ | -30 | - | - | V |
| Breakdown voltage temperature coefficient | $\frac{\Delta V_{(BR)DSS}}{\Delta T_j}$ | $I_D = -1mA$ referenced to 25°C | - | -25 | - | mV/°C |
| Zero gate voltage drain current | I_{DSS} | $V_{DS} = -30V, V_{GS} = 0V$ | - | - | -1 | μA |
| Gate - Source leakage current | I_{GSS} | $V_{GS} = \pm 20V, V_{DS} = 0V$ | - | - | ± 10 | μA |
| Gate threshold voltage | $V_{GS(th)}$ | $V_{DS} = -10V, I_D = -1mA$ | -1.0 | - | -2.5 | V |
| Gate threshold voltage temperature coefficient | $\frac{\Delta V_{(GS)th}}{\Delta T_j}$ | $I_D = -1mA$ referenced to 25°C | - | 3.9 | - | mV/°C |
| Static drain - source on - state resistance | $R_{DS(on)}^{*6}$ | $V_{GS} = -10V, I_D = -14A$ | - | 5.0 | 7.0 | m Ω |
| | | $V_{GS} = -4.5V, I_D = -7A$ | - | 6.7 | 9.4 | |
| | | $V_{GS} = -4.0V, I_D = -7A$ | - | 7.3 | 10.2 | |
| | | $V_{GS} = -10V, I_D = -14A, T_j = 125^\circ\text{C}$ | - | 7.5 | 10.5 | |
| Gate input resistance | R_G | $f = 1\text{MHz}, \text{open drain}$ | - | 3.0 | - | Ω |
| Transconductance | g_{fs}^{*6} | $V_{DS} = -10V, I_D = -14A$ | 20 | 40 | - | S |

*1 Limited only by maximum temperature allowed.

*2 $P_w \leq 10\mu\text{s}$, Duty cycle $\leq 1\%$

*3 $L \approx 10\mu\text{H}$, $V_{DD} = -15V$, $R_g = 25\Omega$, starting $T_j = 25^\circ\text{C}$

*4 Mounted on a ceramic board (30×30×0.8mm)

*5 Mounted on a FR4 (20×20×0.8mm)

●Electrical characteristics($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Conditions | Values | | | Unit |
|------------------------------|-------------------|--|--------|------|------|------|
| | | | Min. | Typ. | Max. | |
| Input capacitance | C_{iss} | $V_{GS} = 0\text{V}$ | - | 8000 | - | pF |
| Output capacitance | C_{oss} | $V_{DS} = -10\text{V}$ | - | 1000 | - | |
| Reverse transfer capacitance | C_{rss} | $f = 1\text{MHz}$ | - | 1000 | - | |
| Turn - on delay time | $t_{d(on)}^{*6}$ | $V_{DD} \approx -15\text{V}, V_{GS} = -10\text{V}$ | - | 32 | - | ns |
| Rise time | t_r^{*6} | $I_D = -7\text{A}$ | - | 80 | - | |
| Turn - off delay time | $t_{d(off)}^{*6}$ | $R_L = 2.1\Omega$ | - | 360 | - | |
| Fall time | t_f^{*6} | $R_G = 10\Omega$ | - | 200 | - | |

●Gate Charge characteristics($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Conditions | Values | | | Unit |
|----------------------|---------------|---|--------|------|------|------|
| | | | Min. | Typ. | Max. | |
| Total gate charge | Q_g^{*6} | $V_{DD} \approx -15\text{V}, I_D = -14\text{A}$ $V_{GS} = -5\text{V}$ | - | 80 | - | nC |
| | | $V_{DD} \approx -15\text{V}, I_D = -14\text{A}$ $V_{GS} = -10\text{V}$ | - | 150 | - | |
| Gate - Source charge | Q_{gs}^{*6} | $V_{DD} \approx -15\text{V}, I_D = -14\text{A}$ | - | 18 | - | |
| Gate - Drain charge | Q_{gd}^{*6} | $V_{GS} = -5\text{V}$ | - | 30 | - | |

●Body diode electrical characteristics (Source-Drain)($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Conditions | Values | | | Unit |
|---|---------------|---|--------|------|------|---------------|
| | | | Min. | Typ. | Max. | |
| Inverse diode continuous, forward current | I_S^{*1} | $T_a = 25^\circ\text{C}$ | - | - | -1.6 | A |
| Forward voltage | V_{SD}^{*6} | $V_{GS} = 0\text{V}, I_S = -14\text{A}$ | - | - | -1.2 | V |
| Reverse recovery time | t_{rr}^{*6} | $I_S = -14\text{A}$ | - | 50 | 100 | ns |
| Reverse recovery charge | Q_{rr}^{*6} | $di/dt = 100\text{A} / \mu\text{s}$ | - | 50 | 100 | μC |

*6 Pulsed

●Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

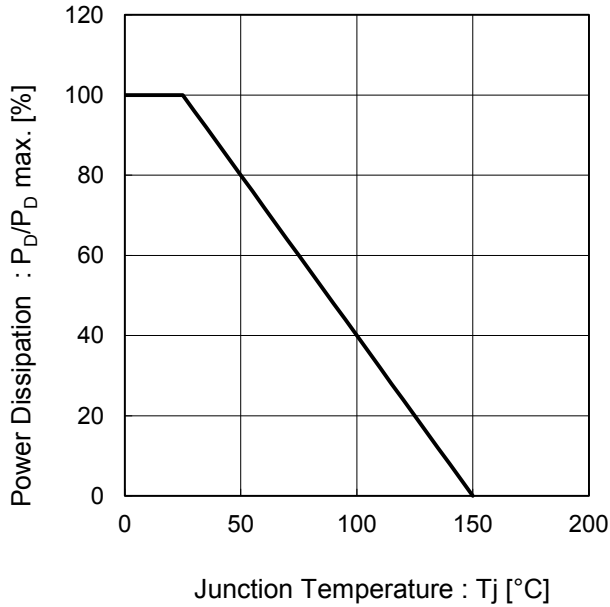


Fig.2 Maximum Safe Operating Area

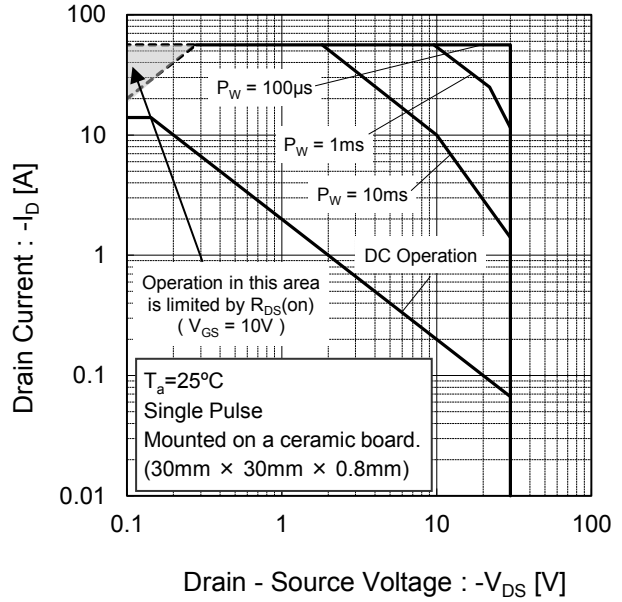


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

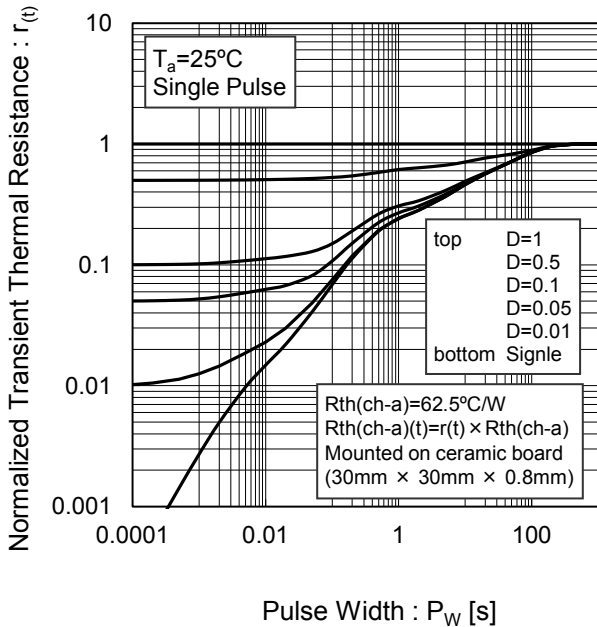
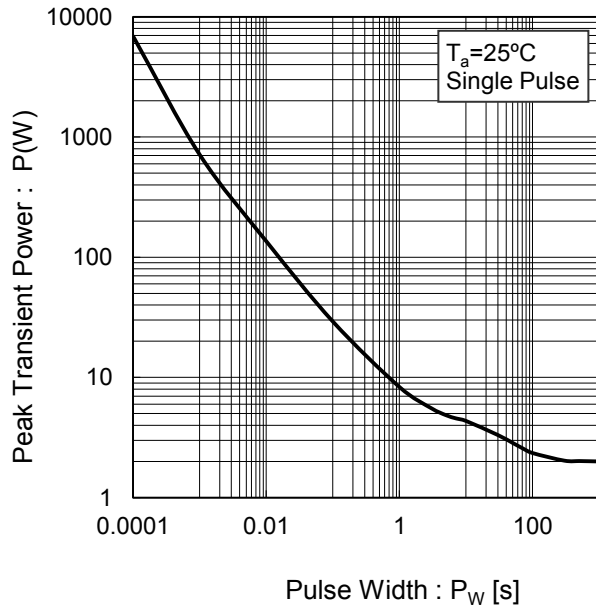


Fig.4 Single Pulse Maximum Power dissipation



●Electrical characteristic curves

Fig.5 Avalanche Current vs Inductive Load

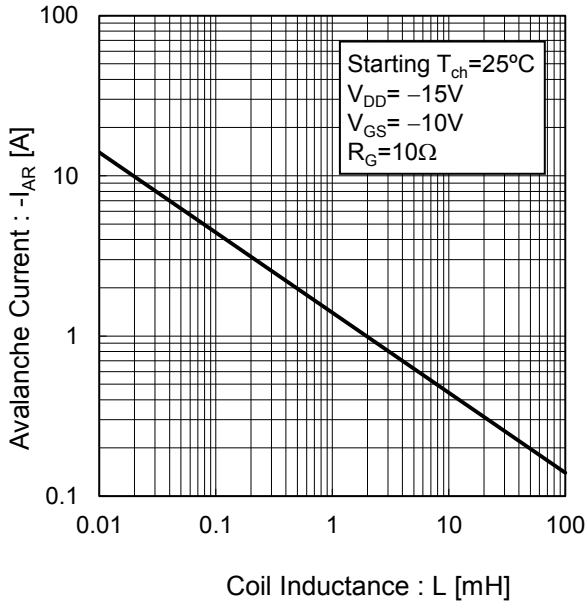


Fig.6 Avalanche Energy Derating Curve vs Junction Temperature

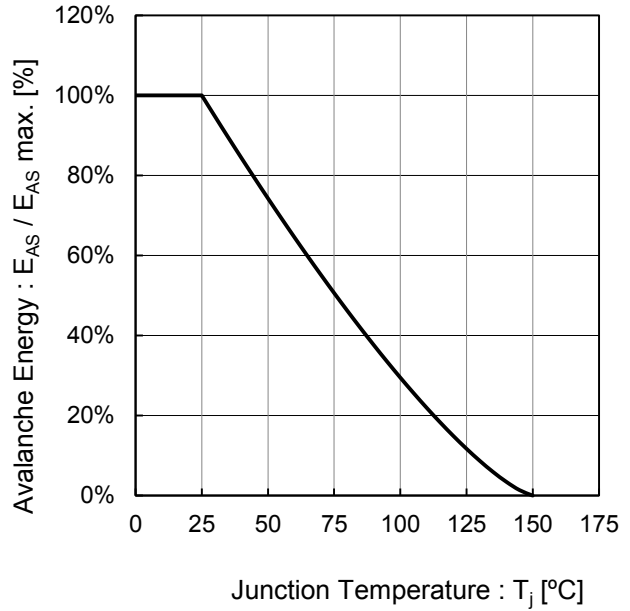


Fig.7 Typical Output Characteristics(I)

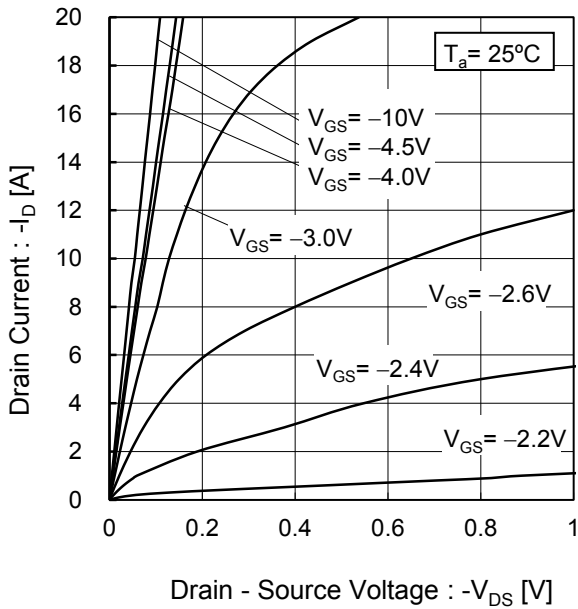
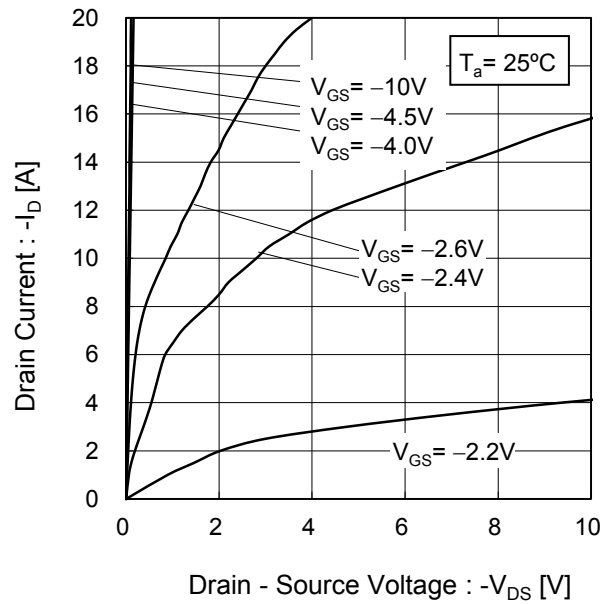


Fig.8 Typical Output Characteristics(II)



●Electrical characteristic curves

Fig.9 Breakdown Voltage vs. Junction Temperature

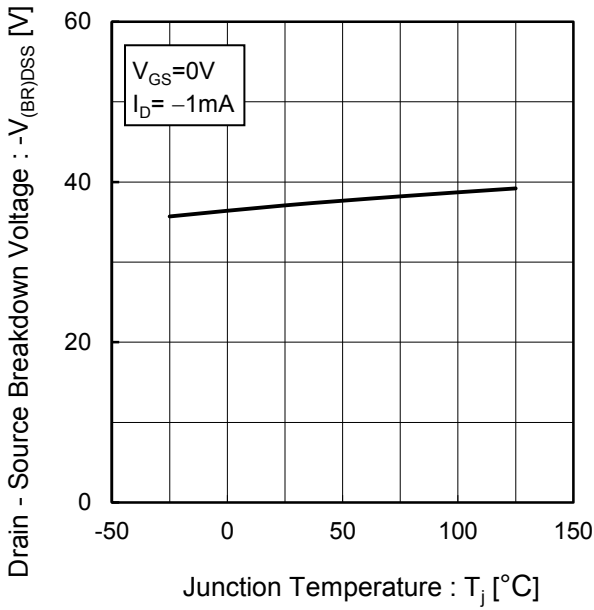


Fig.10 Typical Transfer Characteristics

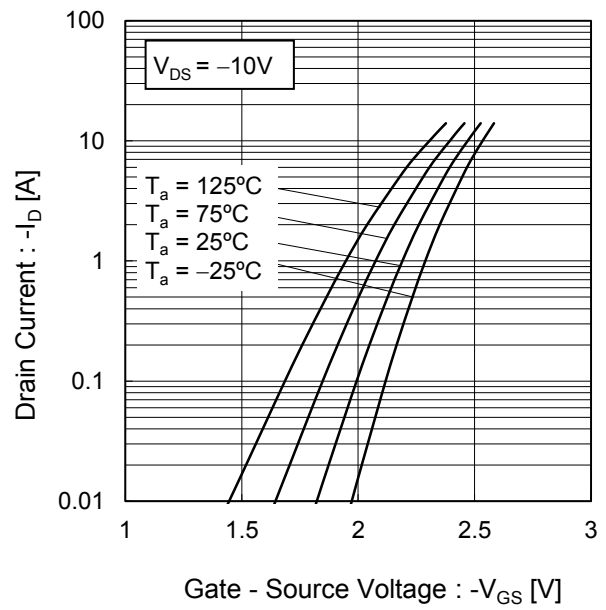


Fig.11 Gate Threshold Voltage vs. Junction Temperature

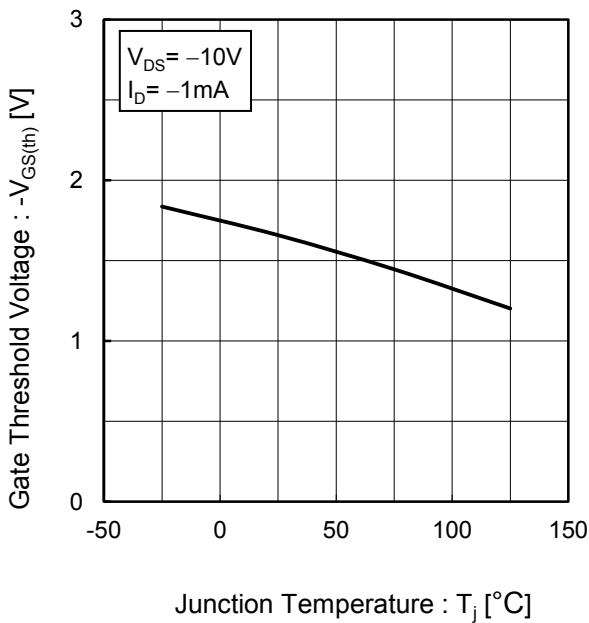
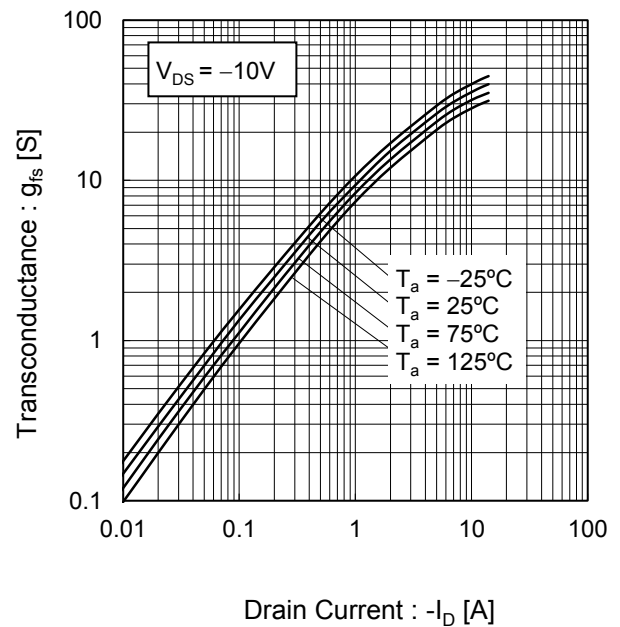


Fig.12 Transconductance vs. Drain Current



●Electrical characteristic curves

Fig.13 Drain Current Derating Curve

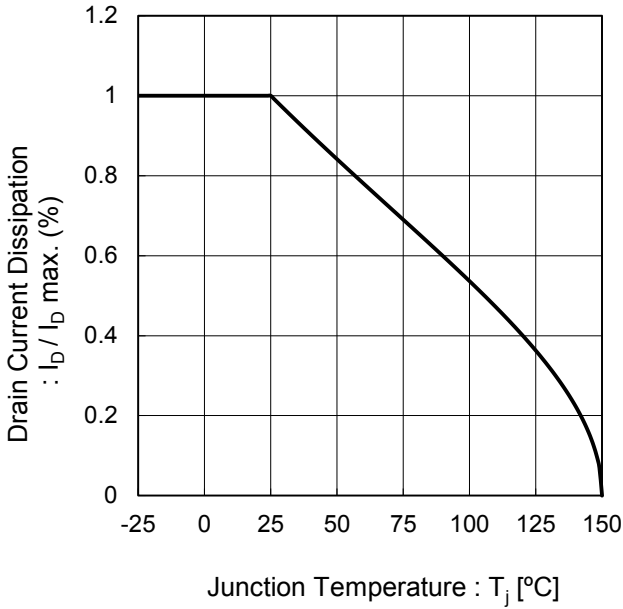


Fig.14 Static Drain - Source On - State Resistance vs. Gate Source Voltage

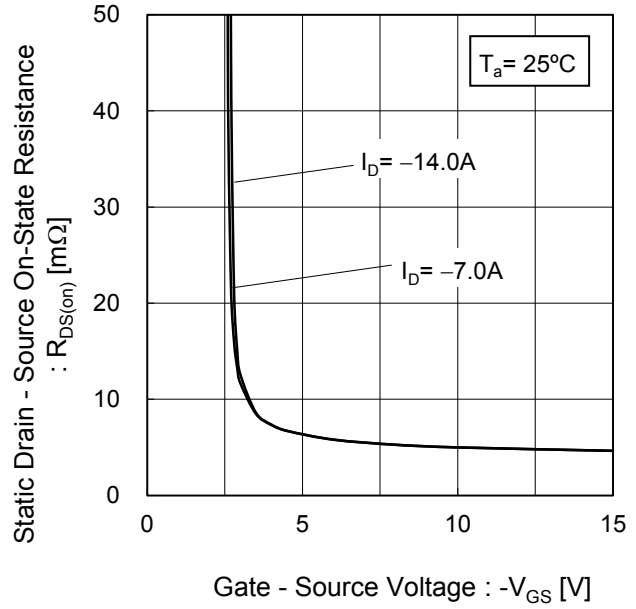


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current(I)

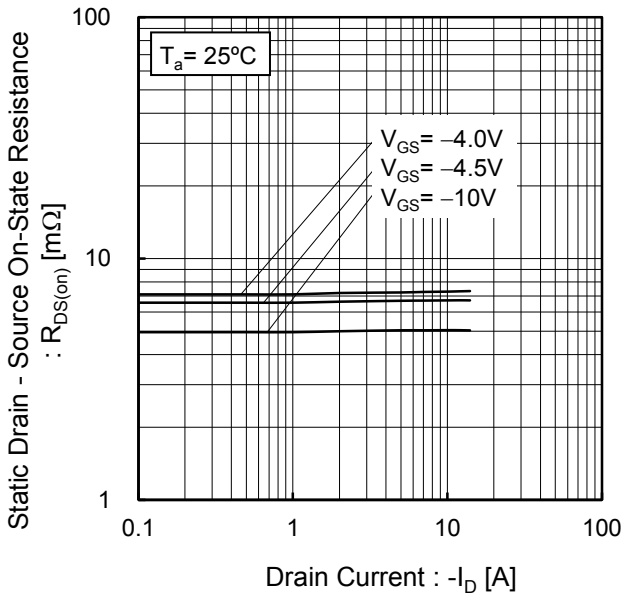
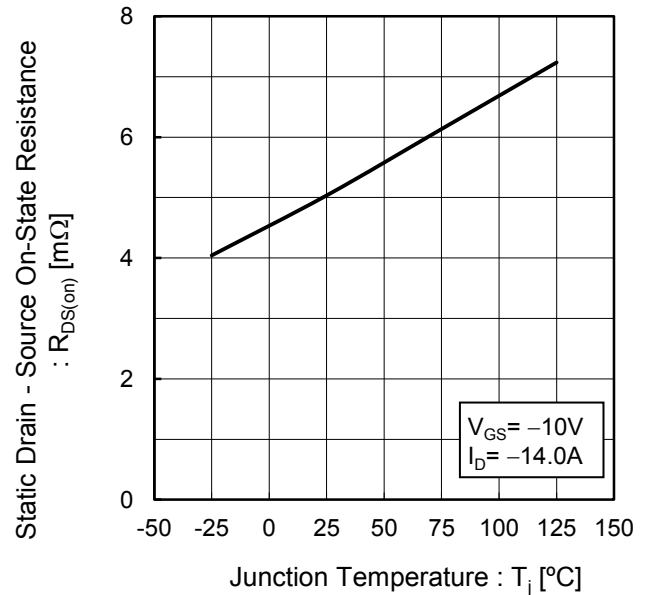


Fig.16 Static Drain - Source On - State Resistance vs. Junction Temperature



●Electrical characteristic curves

Fig.17 Static Drain - Source On - State Resistance vs. Drain Current(II)

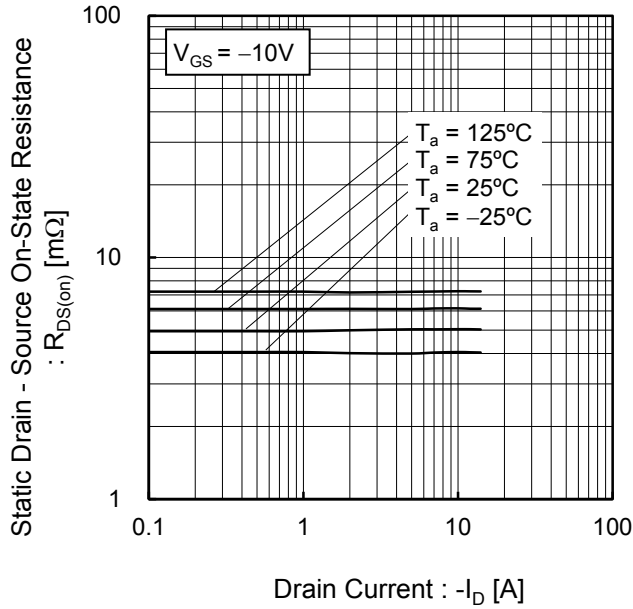


Fig.18 Static Drain - Source On - State Resistance vs. Drain Current(III)

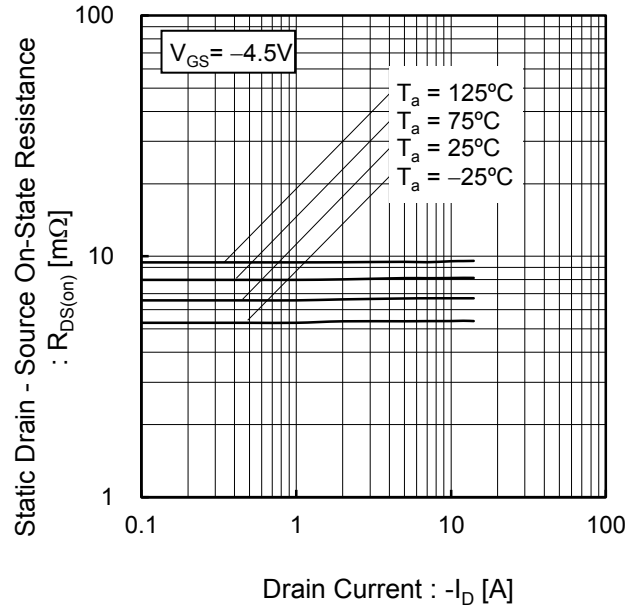
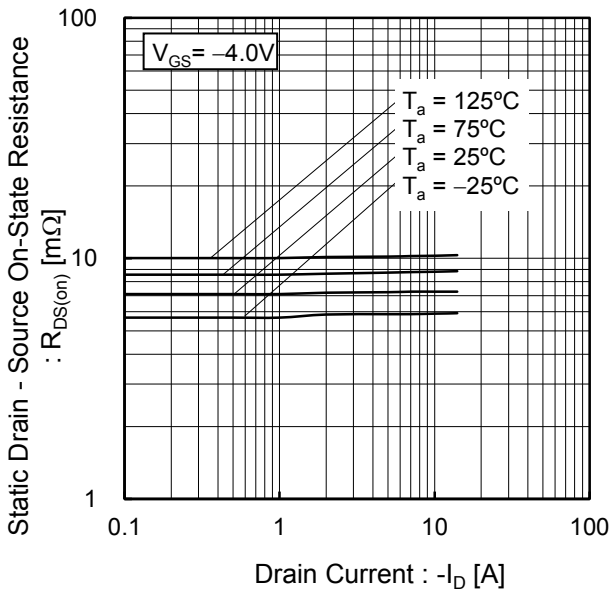


Fig.19 Static Drain - Source On - State Resistance vs. Drain Current(IV)



●Electrical characteristic curves

Fig.20 Typical Capacitance vs. Drain - Source Voltage

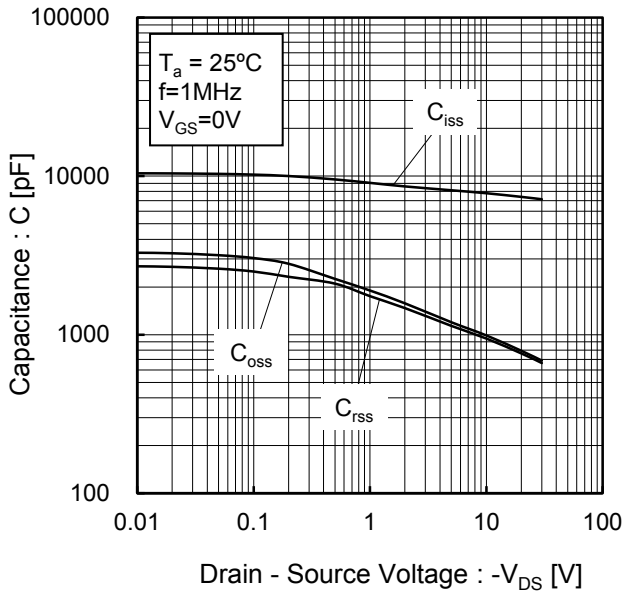


Fig.21 Switching Characteristics

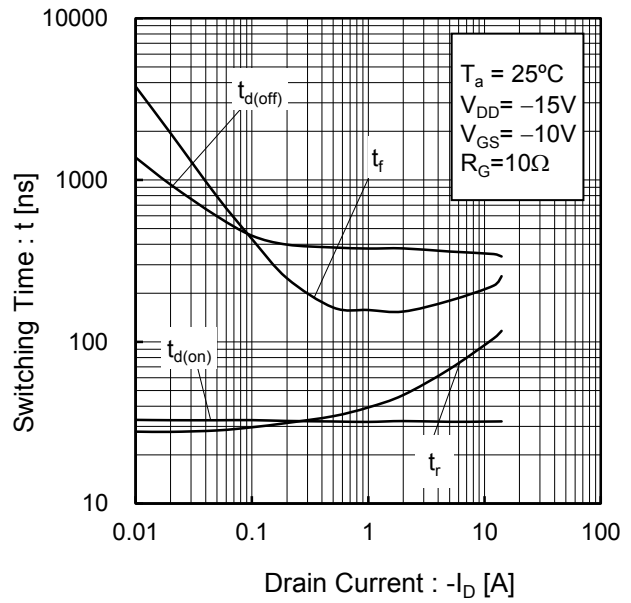


Fig.22 Dynamic Input Characteristics

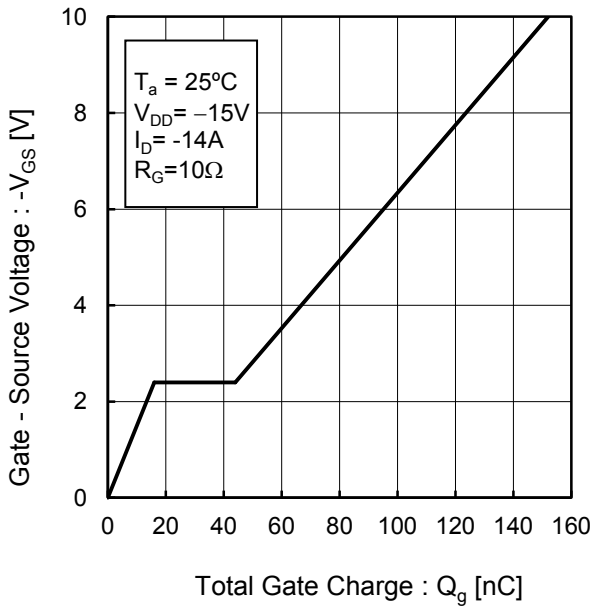
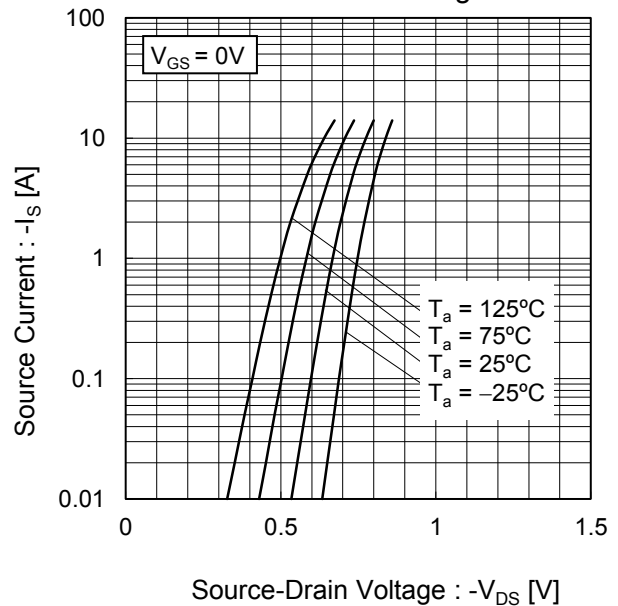


Fig.23 Source Current vs. Source Drain Voltage



●Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

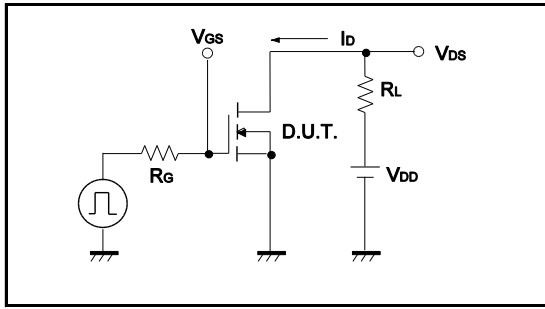


Fig.1-2 Switching Waveforms

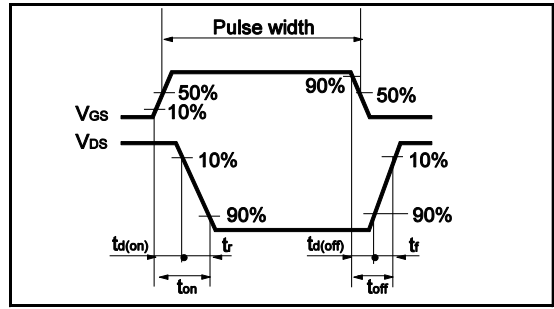


Fig.2-1 Gate Charge Measurement Circuit

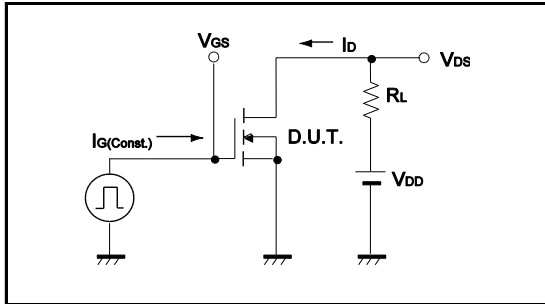


Fig.2-2 Gate Charge Waveform

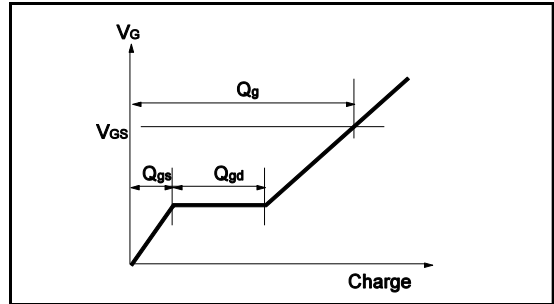


Fig.3-1 Avalanche Measurement Circuit

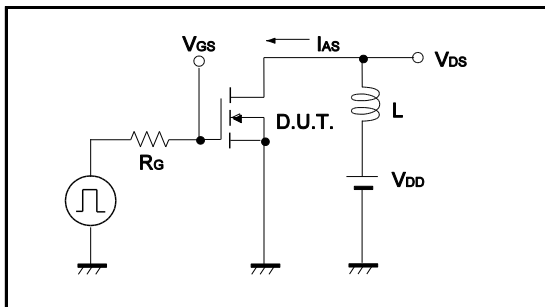
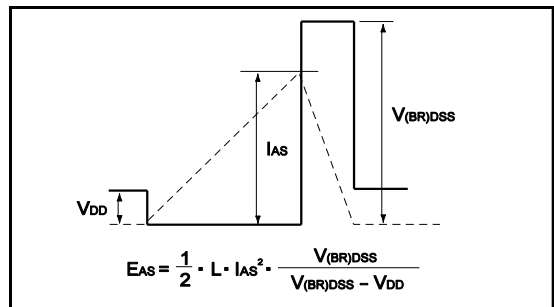
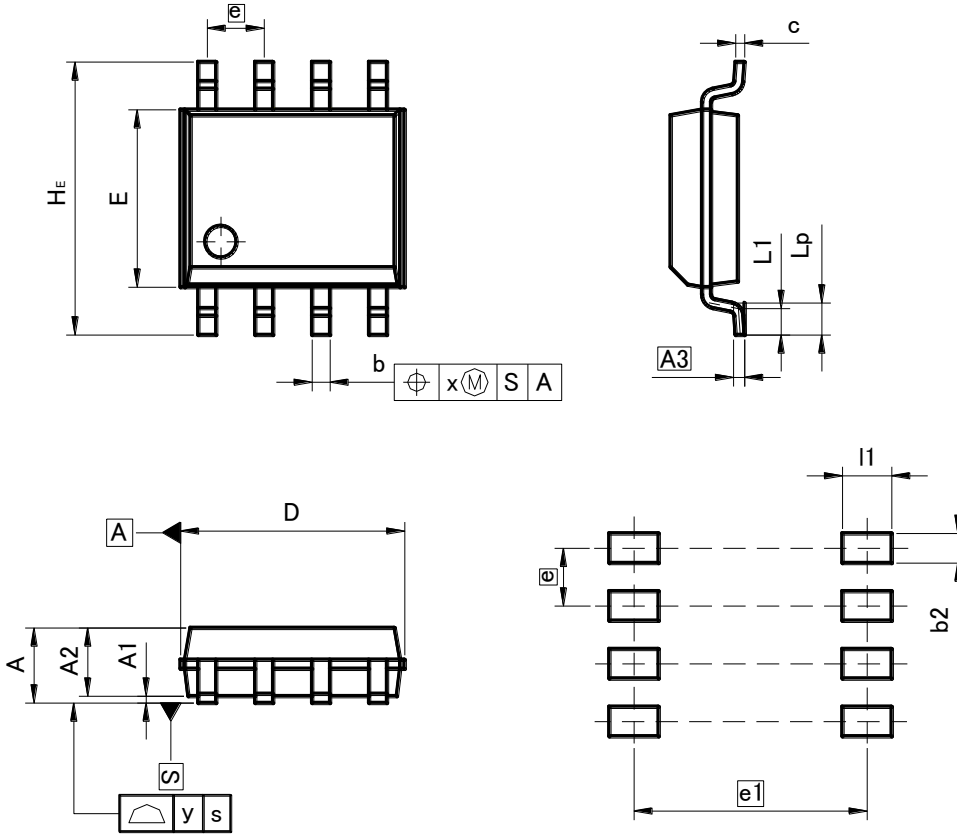


Fig.3-2 Avalanche Waveform



●Dimensions (Unit : mm)

SOP8



Pattern of terminal position areas

| DIM | MILIMETERS | | INCHES | |
|-----|------------|------|--------|-------|
| | MIN | MAX | MIN | MAX |
| A | - | 1.75 | - | 0.069 |
| A1 | 0.15 | | 0.006 | |
| A2 | 1.40 | 1.60 | 0.055 | 0.063 |
| A3 | 0.25 | | 0.01 | |
| b | 0.30 | 0.50 | 0.012 | 0.02 |
| c | 0.10 | 0.30 | 0.004 | 0.012 |
| D | 4.80 | 5.20 | 0.189 | 0.205 |
| E | 3.75 | 4.05 | 0.148 | 0.159 |
| e | 1.27 | | 0.05 | |
| HE | 5.70 | 6.30 | 0.224 | 0.248 |
| L1 | 0.50 | 0.70 | 0.02 | 0.028 |
| Lp | 0.65 | 0.85 | 0.026 | 0.033 |
| x | 0.15 | | 0.006 | |
| y | 0.10 | | 0.004 | |

| DIM | MILIMETERS | | INCHES | |
|-----|------------|------|--------|-------|
| | MIN | MAX | MIN | MAX |
| b2 | - | 0.65 | - | 0.026 |
| e1 | 5.15 | | 0.203 | |
| l1 | - | 1.15 | - | 0.045 |

Dimension in mm/inches

Notes

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